**Description**

HexPly® M9.6H is a hotmelt, thermosetting, moderate tack epoxy resin matrix, specifically designed for prepreg applications at which short cure cycles of 100°C and above are required. M9.6H can be used for manufacture of large industrial components, suitable for cure of thin and thick sections. M9.6H exhibits a long out-life at ambient conditions.

**Resin Matrix Properties**

*Dynamic Thermal Properties by DSC (ISO 11357-5)*

(cure -40 to 270°C @10°C/min) (1)

- Uncured $T_g$: 1 – 9°C
- $T_{Onset}$: 126 – 136°C
- $T_{Peak}$: 139 – 149°C
- Enthalpy: 240J/g +/-25%

(1) Data obtained from neat resin upon delivery

*Isothermal Cure Properties by DSC*

<table>
<thead>
<tr>
<th>Temperature</th>
<th>Cure Time (95%) (2)</th>
<th>Tolerance</th>
</tr>
</thead>
<tbody>
<tr>
<td>100°C</td>
<td>70min</td>
<td>+/-15min</td>
</tr>
<tr>
<td>110°C</td>
<td>45min</td>
<td>+/-10min</td>
</tr>
<tr>
<td>120°C</td>
<td>33min</td>
<td>+/-7min</td>
</tr>
</tbody>
</table>

(2) time to 95% conversion (ISO 11357-5), total scan time 120min

- Typical cured $T_g$: 110°C +/-5°C (following a 30min cure @120°C) (3)
- Optimum cured $T_g$: 125°C +/-5°C (following a 120min cure @120°C) (3)

(3) according to ISO 11357-2 using a 10°C/min ramp rate, -40 to 270°C

- Density (ISO1183-1): 1.1 – 1.22g/cm³
- Color: Off white - Yellowish
- Tack: Moderate
Typical Viscosity Profile
(Data obtained from plate-plate rheometry, temperature run in reference to ISO 6721-10; Representative for a selected, single batch)

Dynamic Complex Viscosity of HexPly® M9.6H @ 2°C/min

![Graph showing dynamic complex viscosity of HexPly® M9.6H at 2°C/min. The x-axis represents temperature in °C ranging from 20 to 160, and the y-axis represents complex viscosity in Pa·s ranging from 1.00E-01 to 1.00E+06. The graph plots a smooth curve indicating the viscosity profile as a function of temperature.]
**HexPly® M9.6H**  
Medium Temperature Curing Epoxy Resin Matrix for Prepregs

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**Shelf Life**  
*(Stored sealed, in dry conditions and in absence of direct sunlight)*

- @ +23°C  
  6 weeks

- @ +5°C  
  6 months

- @ -18°C  
  18 months

(4) Shelf Life refers to the minimum time at given temperature after which the resin is being impaired in its thermal or rheological properties. An increase in uncured $T_g$ above NTP temperature limitation (NIST) defines the end of shelf-life of the resin matrix.

**Typical Curing Conditions**

- Recommended heat-up rate: 0.5 – 5°C/min
- Recommended cure cycle: 25 – 80°C @1°C/min, 60min @80°C, 80 – 120°C @1°C/min, 60min @120°C
- Pressure gauge: 0.5 – 5bar

Dependent on the application, alternative cure temperatures than the ones from 100°C – 120°C might be applied but degree of conversion and cured $T_g$ can deviate from stated ranges. The optimum cure cycle, heat-up rate and dwell period is dependent on component size, layup construction, oven capacity and thermal mass of tool.
Precautions for Use
HexPly® M9.6H is exclusively available in prepreg or semipreg format and a Safety Data Sheet can be provided for this product. The usual precautions when handling uncured synthetic resins and fine fibrous materials should be observed. The use of clean disposable inert gloves provides protection for the operator and avoids contamination of material and components.

For more information
Hexcel is a leading worldwide supplier of composite materials to aerospace and industrial markets. Our comprehensive range includes:

- HexTow® carbon fibers
- HexForce® reinforcements
- HexPly® prepregs
- HexMC® molding compounds
- HexFlow® RTM resins
- Redux® adhesives
- HexTool® tooling materials
- HexWeb® honeycombs
- Acousti-Cap® sound attenuating honeycomb
- Engineered core
- Engineered products

For US quotes, orders and product information call toll-free 1-800-688-7734. For other worldwide sales office telephone numbers and a full address list, please go to:

http://www.hexcel.com/contact/salesoffice

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